Dual Supply ECL to TTL1:8 Clock Driver

Description

The MC10H/100H643 is a dual supply, low skew translating 1:8 clock driver. Devices in the ON Semiconductor H643 translator series utilize the PLCC-28 for optimal power pinning, signal flow through and electrical performance. The dual-supply H643 is similar to the H641, which is a single-supply 1:9 version of the same function.

The device features a 48 mA TTL output stage, with AC performance specified into a 50 pF load capacitance. A Latch is provided on–chip. When LEN is LOW (or left open, in which case it is pulled LOW by the internal pulldowns) the latch is transparent. A HIGH on the enable pin $(\overline{\rm EN})$ forces all outputs LOW.

The 10H version is compatible with MECL 10H™ ECL logic levels. The 100H version is compatible with 100K levels.

Features

- ECL/TTL Version of Popular ECLinPS™ E111
- Low Skew Within Device 0.5 ns
- Guaranteed Skew Spec Part-to-Part 1.0 ns
- Latch
- Differential Internal Design
- V_{BB} Output
- Dual Supply
- Reset/Enable
- Multiple TTL and ECL Power/Ground Pins
- Pb-Free Packages are Available*



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PLCC-28 FN SUFFIX CASE 776

MARKING DIAGRAM*



xxx = 10 or 100

A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

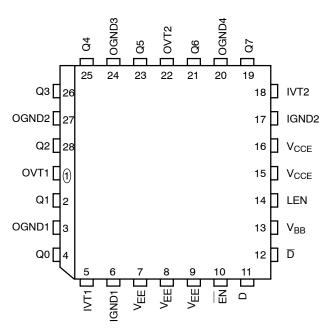


Figure 1. Pinout: PLCC-28 (Top View)

Table 1. PIN DESCRIPTION

PIN	FUNCTION
OGND	TTL Output Ground (0V)
OVT	TTL Output V _{CC} (+5.0V)
IGND	Internal TTL GND (0V)
IVT	Internal TTL V _{CC} (+5.0V)
V_{EE}	ECL V _{EE} (-5.2/-4.5V)
V_{CCE}	ECL Ground (0V)
D, D	Signal Input (ECL)
V_{BB}	V _{BB} Reference Output
Q0 – Q7	Signal Outputs (TTL)
EN	Enable Input (ECL)
LEN	Latch Enable Input (ECL)

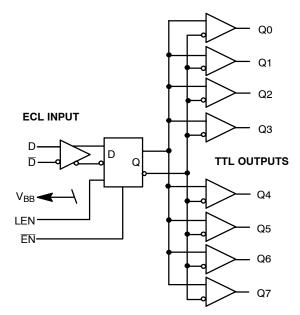


Figure 2. Logic Diagram

Table 2. TRUTH TABLE

D	LEN	EN	Q
L H X X	L H X	LLLT	L H Q L

Table 3. DC CHARACTERISTICS (IVT = OVT = $5.0 \text{ V} \pm 5\%$; V_{EE} = $-5.2 \text{ V} \pm 5\%$ (10H Version); V_{EE} = -4.2 V to -5.5 V (100H Version))

				0 °	C	25	°C	85	°C	
Symbol	Characteristic	;	Condition	Min	Max	Min	Max	Min	Max	Unit
I _{EE}		ECL	V _{EE} Pins	-	42	-	42	-	42	mA
I _{CCL}	Power Supply Current	TTL	Total all OVT	-	106	-	106	-	106	mA
I _{CCH}			and IVT pins	_	95	-	95	-	95	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 4. 10H ECL DC CHARACTERISTICS (IVT = OVT = $5.0 \text{ V} \pm 5\%$; $V_{EE} = -5.2 \text{ V} \pm 5\%$ (10H Version))

		0°C		0°C 25°C		°C	85	°C	
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit	
I _{INH} I _{INL}	Input HIGH Current Input LOW Current	_ 0.5	255 -	- 0.5	175 -	- 0.5	175 -	μΑ	
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	
V _{BB}	Output Reference Voltage	-1380	-1270	-1350	-1250	-1310	-1190	mV	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 5. 100H ECL DC CHARACTERISTICS (IVT = OVT = 5.0 V ± [5%; V_{EE} = -4.2 V to -5.5 V (100H))

		0°C		25°C		85°C		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
I _{INH} I _{INL}	Input HIGH Current Input LOW Current	- 0.5	255 -	- 0.5	175 -	- 0.5	175 -	μΑ
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV
V_{BB}	Output Reference Voltage	-1380	-1260	-1380	-1260	-1380	-1260	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 6. DC TTL CHARACTERISTICS (IVT = OVT = $5.0 \text{ V} \pm 5\%$; V_{EE} = $-5.2 \text{ V} \pm 5\%$ (10H Version); V_{EE} = -4.2 V to -5.5 V (100H Version))

			0 °	С	25	°C	85	°C	
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = -3.0 mA I _{OH} = -15 mA	2.5 2.0	-	2.5 2.0	-	2.5 2.0	-	٧
V _{OL}	Output LOW Voltage	I _{OH} = 48 mA	-	0.5	-	0.5	-	0.5	V
IOS	Output Short Circuit Current	V _{OUT} = 0 V	-100	-225	-100	-225	-100	-225	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 7. AC CHARACTERISTICS (IVT = OVT = 5.0 V = 15%; V_{EE} = -5.2 V = 10% (10H); -4.2 V = 10% (10H); V_{CCE} = GND)

			0°	°C	25	°C	85	°C	
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
t _{PLH}	Propagation Delay to Output D LEN EN	CL = 50 pF	4.0 3.5 3.5	5.0 5.5 5.5	4.1 3.5 3.5	5.1 5.5 5.5	4.4 3.9 3.9	5.4 5.9 5.9	ns
t _{SKEW}	Within-Device Skew	(Note 1)	_	0.5	-	0.5		0.5	ns
tw	Pulse Width Out HIGH or LOW @ f _{out} = 50MHz	CL = 50 pF (Note 2)	9.0	11.0	9.0	11.0	9.0	11.0	ns
t _s	Setup Time D		0.75	-	0.75	-	0.75	-	ns
t _h	Hold Time D		0.75	-	0.75	-	0.75	-	ns
t _{RR}	Recovery Time LEN EN		1.25 1.25	- -	1.25 1.25	- -	1.25 1.25	- -	ns
t _{pw}	Minimum Pulse Width LEN EN		1.5 1.5	- -	1.5 1.5	- -	1.5 1.5	- -	ns
t _r t _f	Rise / Fall Times 0.8 V - 2.0 V	CL = 50 pF	_	1.2	-	1.2	-	1.2	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Within-Device skew defined as identical transitions on similar paths through a device.
- 2. Pulse width is defined relative to 1.5 V measurement points on the output waveform.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10H643FN	PLCC-28	37 Units / Rail
MC10H643FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC10H643FNR2	PLCC-28	500 / Tape & Reel
MC10H643FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel
MC100H643FN	PLCC-28	37 Units / Rail
MC100H643FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC100H643FNR2	PLCC-28	500 / Tape & Reel
MC100H643FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

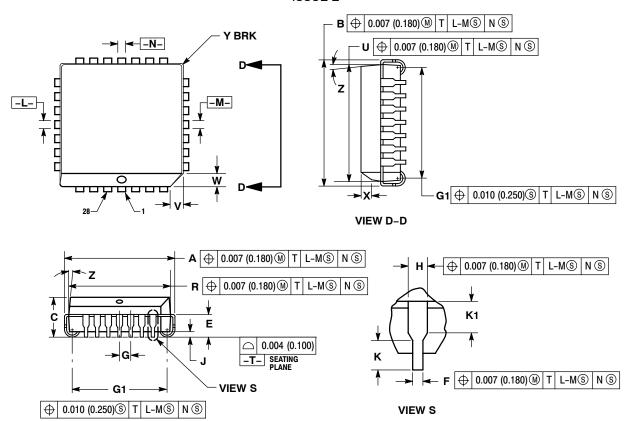
AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

PLCC-28 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 776-02 ISSUE E



- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS
- PLASTIC BODY AT MOLD PARTING LINE.

 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

- 0.010 (0.250) PER SIDE.
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 5. CONTROLLING DIMENSION: INCH.
 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BUIRDS, GATE BUIRDS, AND INTERLIFAD. BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- 7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
С	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
7	0.020		0.51	
K	0.025		0.64	
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2 °	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040		1.02	

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NLSX5011AMX1TCG PCA9306USG SN74GTL1655DGGR SN74AVCA406LZQSR NLSX4014DTR2G NLSX3018DTR2G
LTC1045CSW#PBF LTC1045CN#PBF SY100EL92ZG 74AXP1T34GMH 74AXP1T34GNH LSF0204DPWR PI4ULS3V204LE
ADG3245BRUZ-REEL7 ADG3123BRUZ ADG3245BRUZ ADG3246BCPZ ADG3308BCPZ-REEL ADG3233BRJZ-REEL7
ADG3233BRMZ